

**DISCONTINUED**

THIS DEVICE I

PLEASE CONTACT YOUR  
REPRESENTATIVE FOR INFORMATION

DI

**DISCONTINUE**

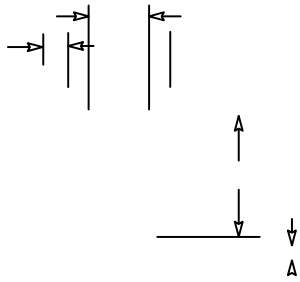
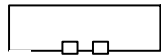
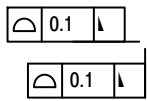
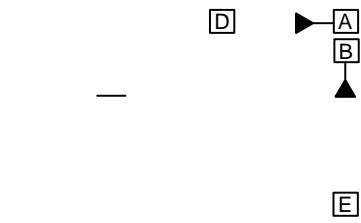
THIS

DISCONTINUED

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CASE 485AW  
ISSUE O

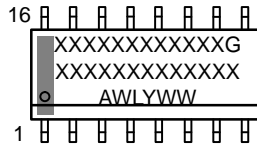
DATE 11 DEC 2008



**SOIC-16 9.90x3.90x1.37 1.27P**  
CASE 751B  
ISSUE M

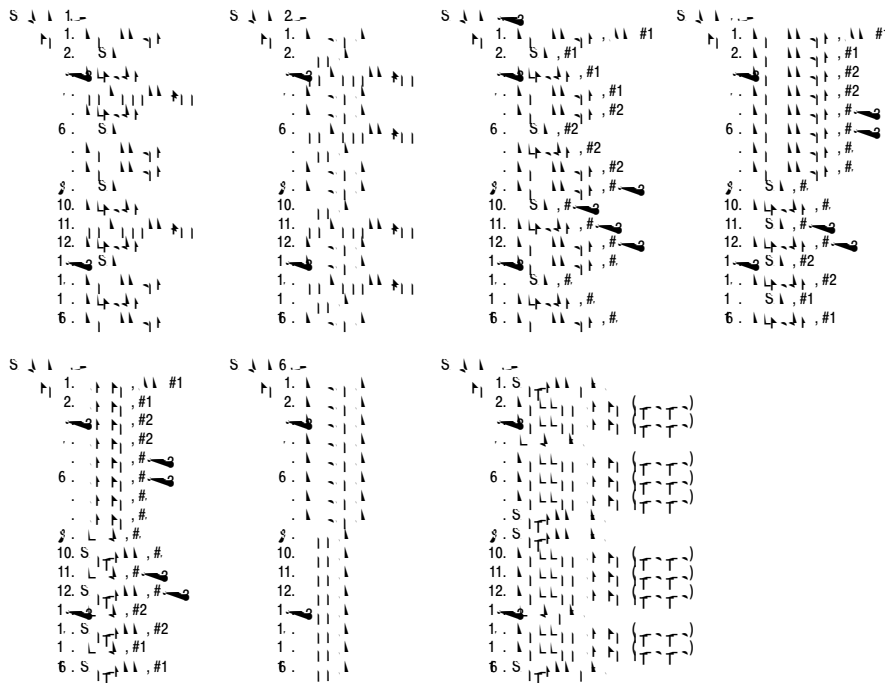
DATE 18 OCT 2024

**GENERIC  
MARKING DIAGRAM\***



XXXXX = Specific Device Code  
A = Assembly Location  
WL = Wafer Lot  
Y = Year  
WW = Work Week  
G = Pb Free Package

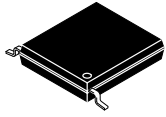
\*This information is generic. Please refer to device data sheet for actual part marking. Pb Free indicator, "G" or microdot "•", may or may not be present. Some products may not follow the Generic Marking.



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<b>DESCRIPTION:</b>	<b>SOIC-16 9.90X3.90X1.37 1.27P</b>	<b>PAGE 2 OF 2</b>

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**SCALE 2:1**

**TSSOP-16 WB**  
CASE 948F  
ISSUE B

DATE 19 OCT 2006

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